PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Jin Hwa CHUNG	11/29/2010
Kee Hae KWON	11/29/2010
II Jin KIM	11/29/2010
Kwang Soo PARK	11/29/2010
Ja Kwan KOO	11/29/2010

RECEIVING PARTY DATA

Name:	Cheil Industries Inc.	
Street Address:	290 Gongdan-dong	
Internal Address:	Gumi-si	
City:	Gyeongsangbuk-do	
State/Country:	REPUBLIC OF KOREA	
Postal Code:	730-710	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12961877

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 1224.054

PATENT

REEL: 025462 FRAME: 0030

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NAME OF SUBMITTER:	Melissa B. Pendleton
Total Attachments: 4 source=AssignmentsUSPTO#page1.tif source=AssignmentsUSPTO#page2.tif source=AssignmentsUSPTO#page3.tif source=AssignmentsUSPTO#page4.tif	

PATENT REEL: 025462 FRAME: 0031 Form **PTO-1595** (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008)

RECORDATION FORM COVER SHEET PATENTS ONLY		
To the Director of the U.S. Patent and Trademark Office: Pleas	e record the attached documents or the new address(es) below.	
1. Name of conveying party(ies) Jin Hwa CHUNG Kee Hae KWON II Jin KIM Kwang Soo PARK Ja Kwan KOO	2. Name and address of receiving party(ies) Name: Cheil Industries, Inc. Internal Address:	
Additional name(s) of conveying party(ies) attached? Yes No. 3. Nature of conveyance/Execution Date(s): Execution Date(s) 11/29/2010 Assignment Merger Security Agreement Change of Name Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other 4. Application or patent number(s): This A. Patent Application No.(s) 12/961,877	Street Address:	
Additional numbers at	ached? Yes X No	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: Summa, Allan & Additon, P.A.	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00	
Internal Address:	Authorized to be charged by credit card Authorized to be charged to deposit account	
Street Address: 11610 N. Community House Road, Suite 200	Enclosed None required (government interest not affecting title)	
City: Charlotte	8. Payment Information	
State: NC	a. Credit Card Last 4 Numbers Expiration Date	
Phone Number: 704-945-6700	b. Deposit Account Number 50-0332	
Fax Number: 704-945-6735 Email Address: mpendleton@summalaw.com	Authorized User Name Melissa B. Pendleton	
9. Signature: /Melissa B. Pendleton/	December 7, 2010	
Signature Melissa B. Pendleton	Date	
Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:	

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

WHEREAS, I, Jin Hwa CHUNG, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2 Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Kee Hae KWON, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2 Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Il Jin KIM, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2 Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; Kwang Soo PARK, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2 Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; and Ja Kwan KOO, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2 Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in Thermoplastic Resin Composition, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from a Korean Application No. 10-2010-0067518, filed July 13, 2010, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in

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and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest-and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest-in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to

said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

Nov. 29 , 2010	Jin Hwa CHUNG
Nov. 29 , 2010	Kee Hae KWON
Nov. 29 , 2010	기 및 지 [1] Jin KIM
Nov. 29 , 2010	Kwang Soo PARK
Nov. 2010	子 对 址 Ja Kwan KOO

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